

2MBI200NB-120-01

IGBT Module

1200V / 200A 2 in one-package

■ Features

- VCE(sat) classified for easy parallel connection
- High speed switching
- Voltage drive
- Low inductance module structure

■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

■ Maximum ratings and characteristics

● Absolute maximum ratings (at Tc=25°C unless otherwise specified)

Item		Symbol	Rating	Unit
Collector-Emitter voltage		V _{CES}	1200	V
Gate-Emitter voltage		V _{GES}	±20	V
Collector current	Continuous	I _c	200	A
	1ms	I _c pulse	400	A
		-I _c	200	A
	1ms	-I _c pulse	400	A
Max. power dissipation		P _c	1500	W
Operating temperature		T _j	+150	°C
Storage temperature		T _{stg}	-40 to +125	°C
Isolation voltage		V _{is}	AC 2500 (1min.)	V
Screw torque		Mounting * ₁	3.5	N·m
		Terminals * ₂	4.5	N·m

*1: Recommendable value : 2.5 to 3.5 N·m (M5) or (M6)

*2: Recommendable value : 3.5 to 4.5 N·m (M6)

● Electrical characteristics (at T_j=25°C unless otherwise specified)

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I _{CES}	—	—	2.0	V _{GE} =0V, V _{CE} =1200V	mA
Gate-Emitter leakage current	I _{GES}	—	—	30	V _{CE} =0V, V _{GE} =±20V	μA
Gate-Emitter threshold voltage	V _{GE(th)}	4.5	—	7.5	V _{CE} =20V, I _c =200mA	V
Collector-Emitter saturation voltage	V _{CE(sat)}	—	—	3.3	V _{GE} =15V, I _c =200A	V
Input capacitance	C _{ies}	—	32000	—	V _{GE} =0V	pF
Output capacitance	C _{oes}	—	11600	—	V _{CE} =10V	μs
Reverse transfer capacitance	C _{res}	—	10320	—	f=1MHz	
Turn-on time	t _{on}	—	0.65	1.2	V _{CC} =600V	
Turn-off time	t _r	—	0.25	0.6	I _c =200A	μs
	t _{off}	—	0.85	1.5	V _{GE} =±15V	
	t _f	—	0.35	0.5	R _G =4.7ohm	
Diode forward on voltage	V _F	—	—	3.0	I _F =200A, V _{GE} =0V	V
Reverse recovery time	t _{rr}	—	—	0.35	I _F =200A	μs

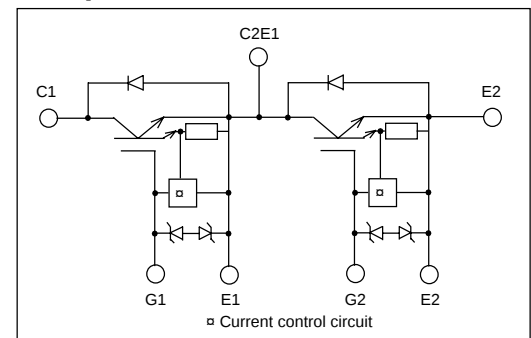
● Thermal resistance characteristics

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	R _{th(j-c)}	—	—	0.085	IGBT	°C/W
	R _{th(j-c)}	—	—	0.18	Diode	°C/W
	R _{th(c-f)*}	—	0.025	—	the base to cooling fin	°C/W

*: This is the value which is defined mounting on the additional cooling fin with thermal compound



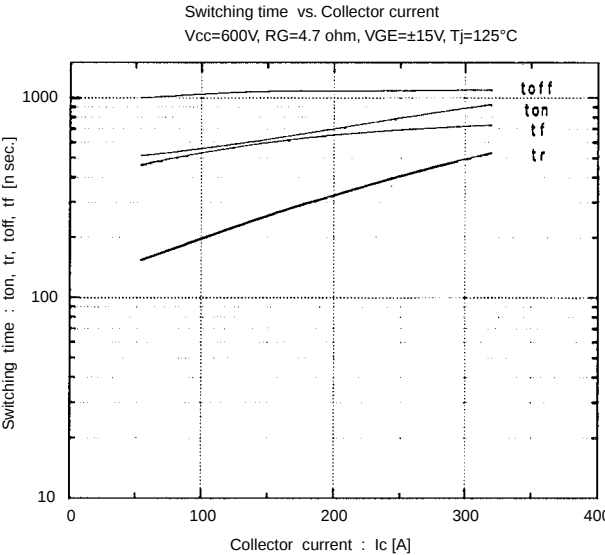
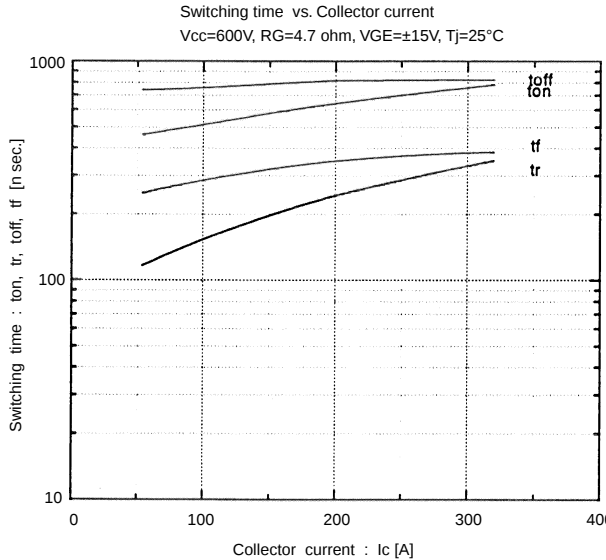
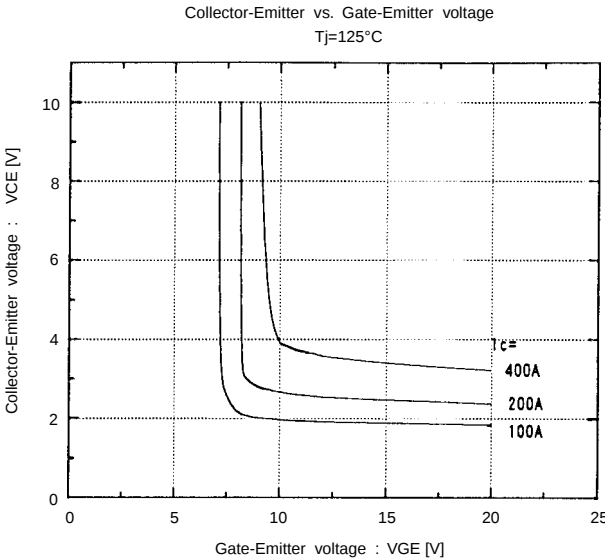
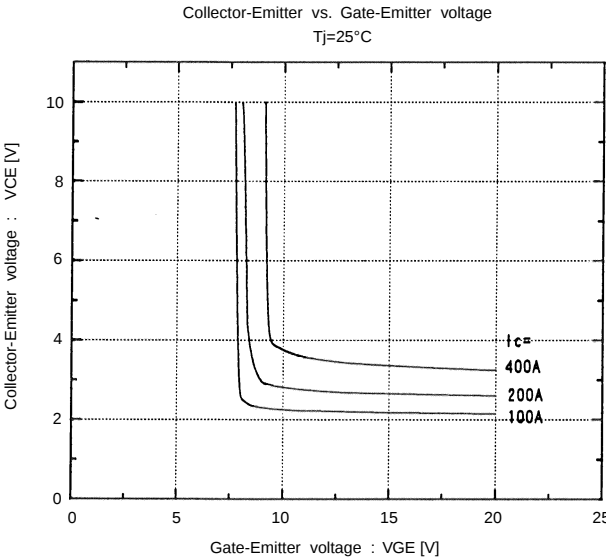
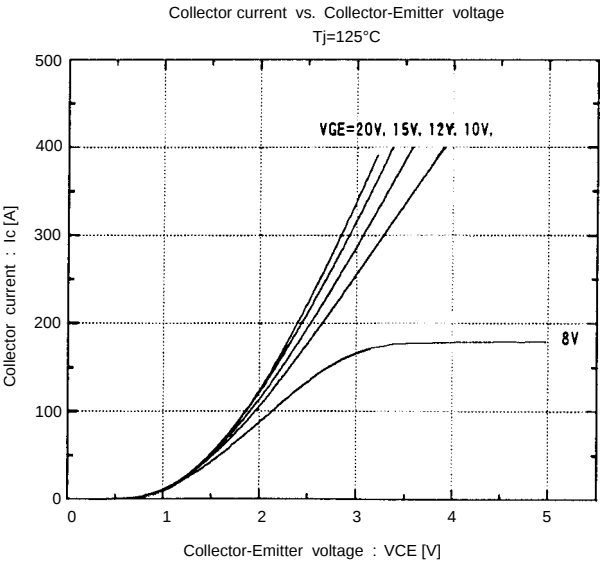
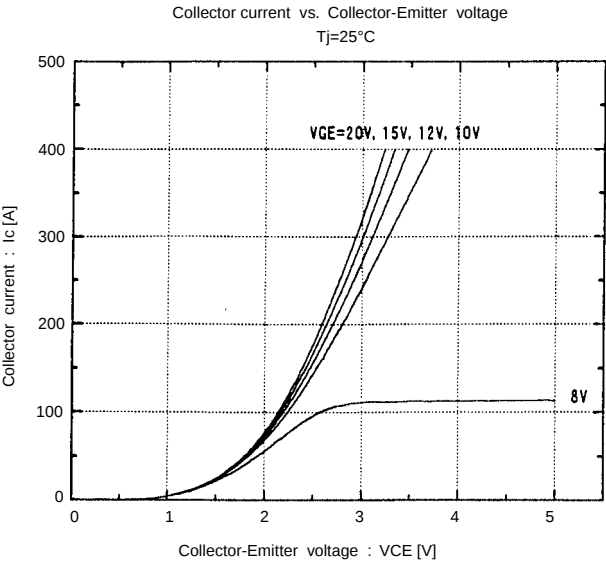
■ Equivalent Circuit Schematic



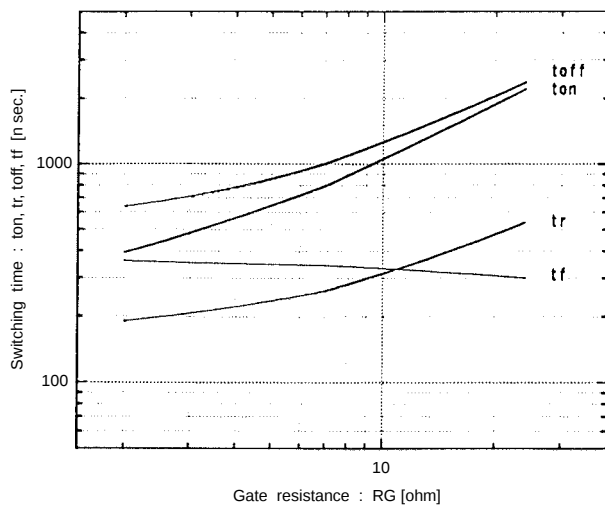
● VCE(sat) classification

Rank	Lenge	Conditions
F	2.25 to 2.50V	I _c = 200A V _{GE} = 15V T _j = 25°C
A	2.40 to 2.65V	
B	2.55 to 2.80V	
C	2.70 to 2.95V	
D	2.85 to 3.10V	
E	3.00 to 3.30V	

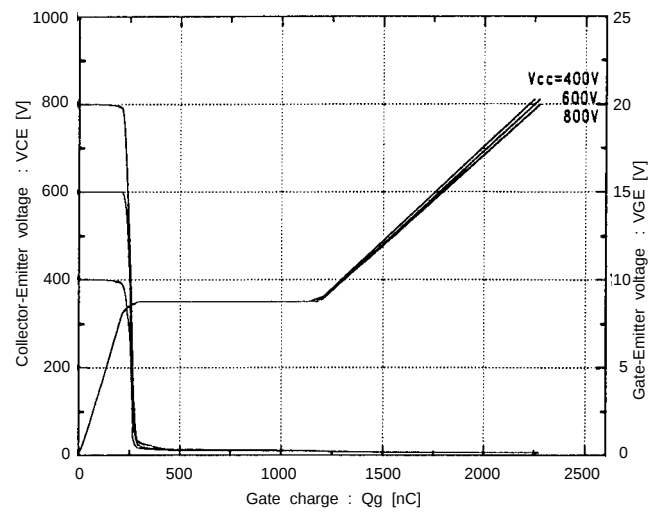
Characteristics (Representative)



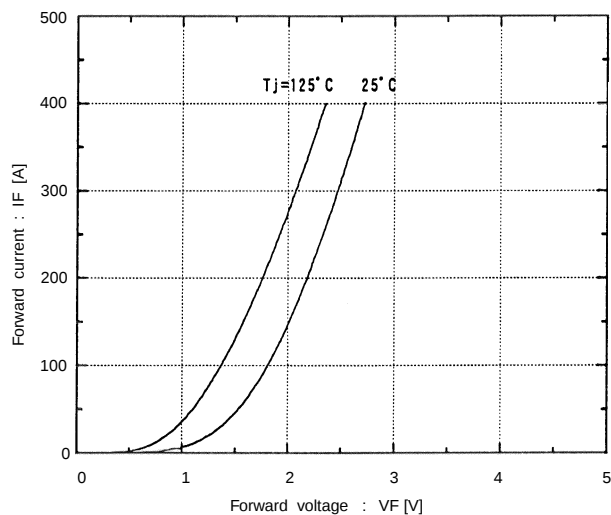
Switching time vs. R_G
 $V_{CC}=600V$, $I_C=200A$, $V_{GE}=\pm 15V$, $T_J=25^\circ C$



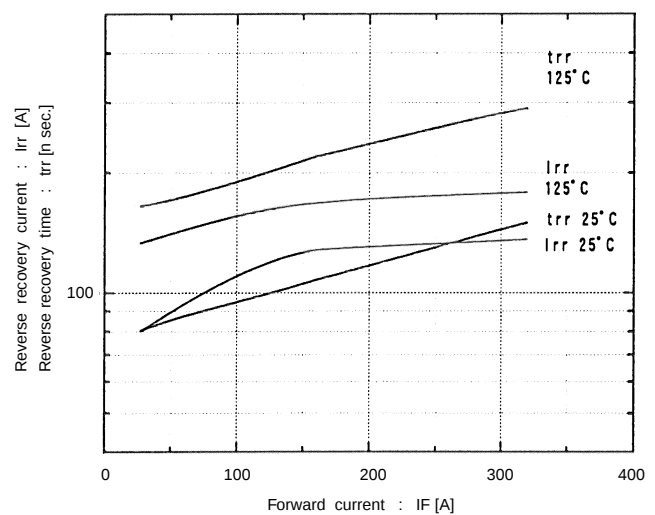
Dynamic input characteristics
 $T_J=25^\circ C$



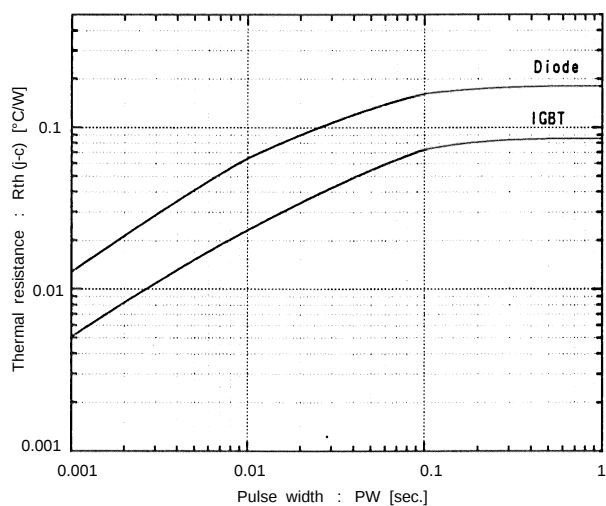
Forward current vs. Forward voltage
 $V_{GE}=0V$



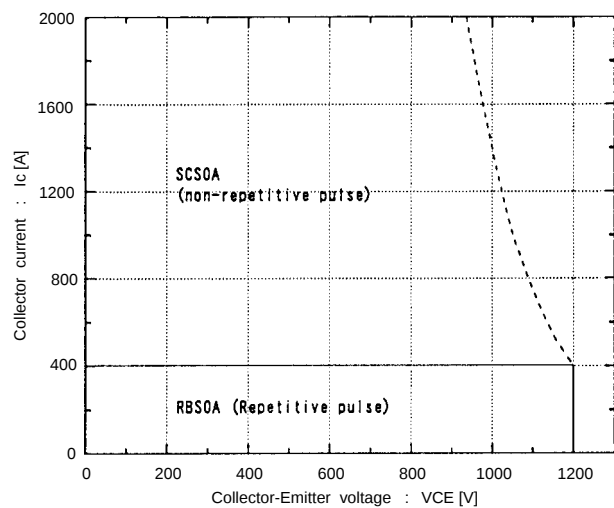
Reverse recovery characteristics
 t_{rr} , I_{rr} , vs. I_F

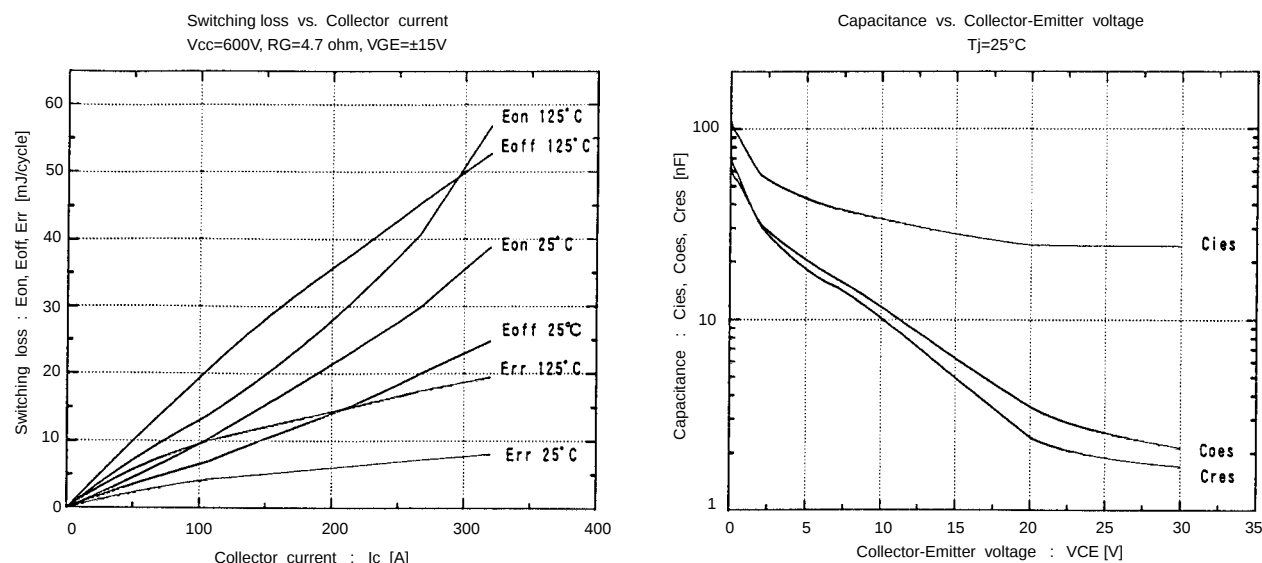


Transient thermal resistance

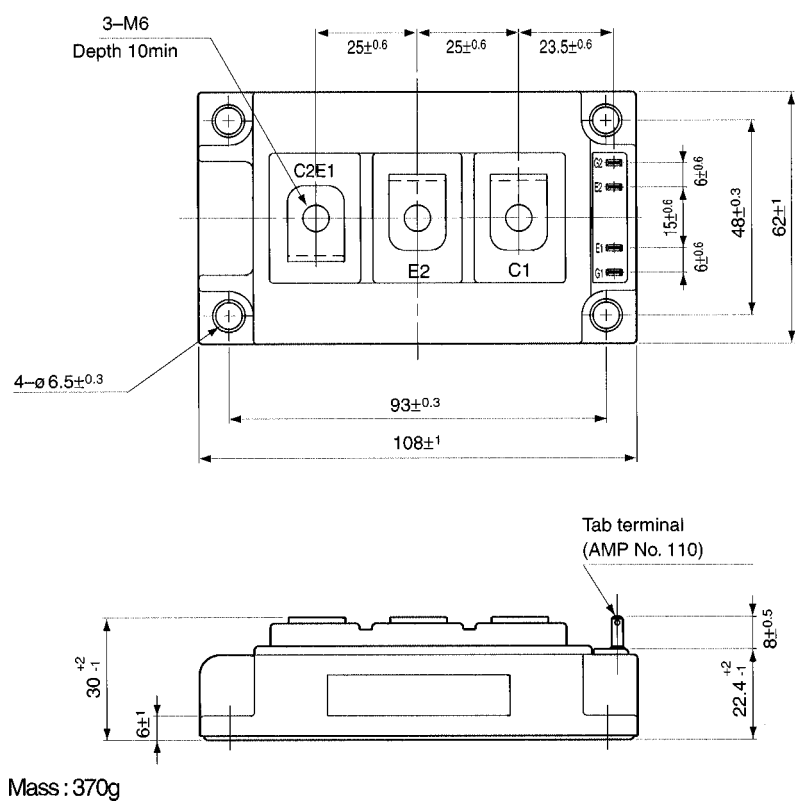


Reversed biased safe operating area
 $+V_{GE}=15V$, $-V_{GE} \leq 15V$, $T_J \leq 125^\circ C$, $R_G \geq 4.7ohm$





■ Outline Drawings, mm



This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.